

The dielectric function and chemical composition the near surface layer of implanted GaAs with In⁺ ions



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Samples and Ion implantation nuclear study

(100) semi-insulating GaAs single crystals implanted with In⁺ ions:

E = 250 keV, fluence 2.7x10¹⁶ cm⁻²

E = 100 keV, fluence 3.0x10¹⁵ cm⁻²

The current density of ion beam at a collector was 1.0 mA/cm²

UNIMAS ion implanter

Institute of Physics

Maria Curie-Skłodowska University

The irradiated samples were covered with protective layers of Si₃N₄ having a thicknesses of about 100 nm, before the thermal annealing. Then the samples were annealed isobarically in the flow of argon at 800 C. The annealing time was 2h.

RBS/NR -EG5 at room temperature

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SIMNRA code - study of spectrum

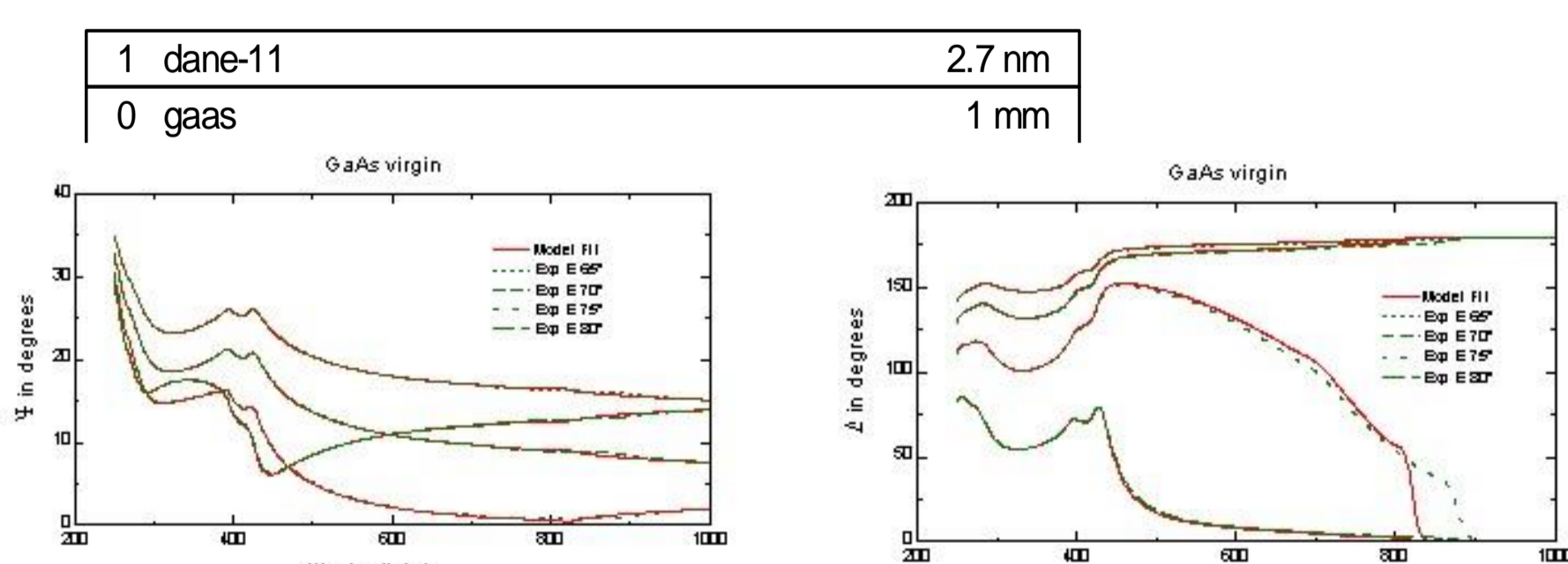
RBS/NR

X-ray photoelectron spectroscopy (XPS) was performed using a Thermo Scientific K Alpha spectrometer equipped with a monochromatic Al Ka radiation source (E_{Al, Ka}=1486.6 eV). JINR DUBNA

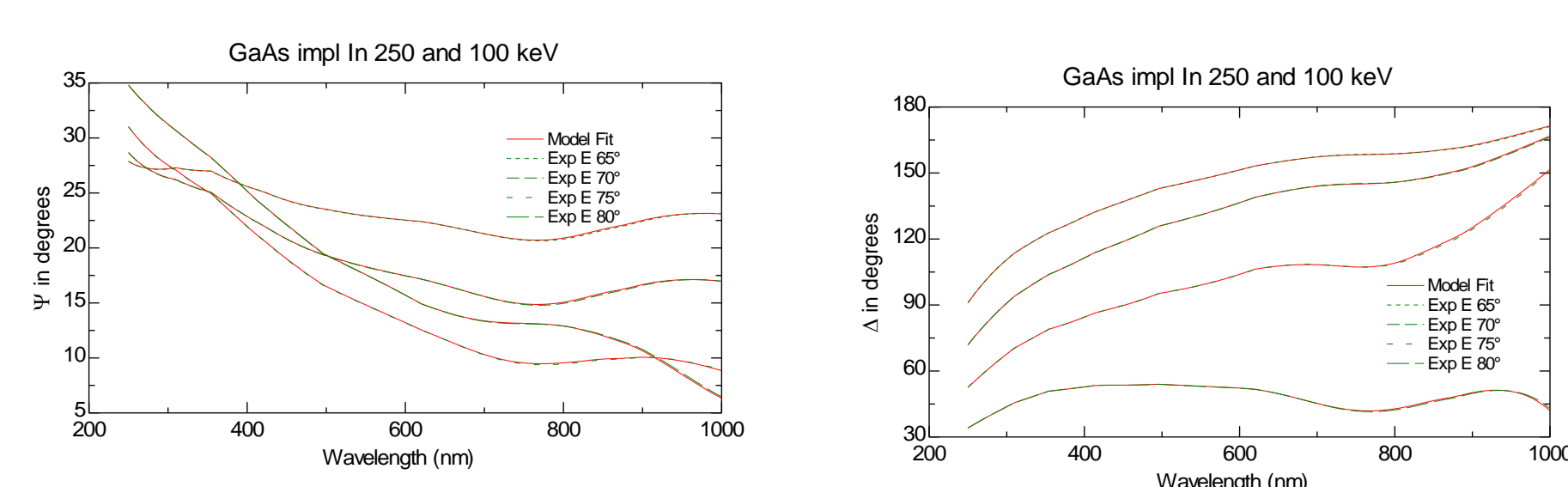
The analyzer was operated in CAE mode with a pass energy of 20 eV.

Ellipsometric investigation

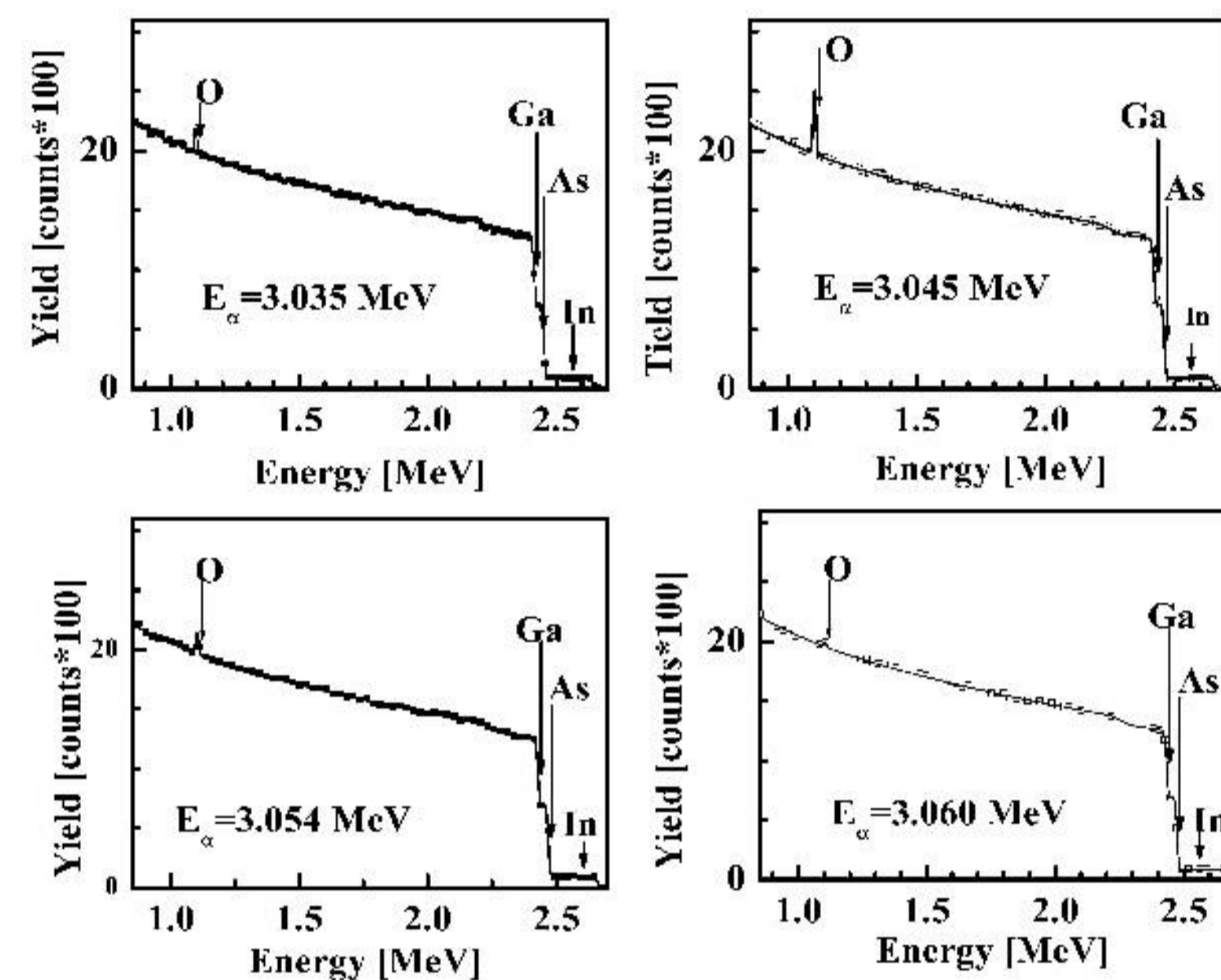
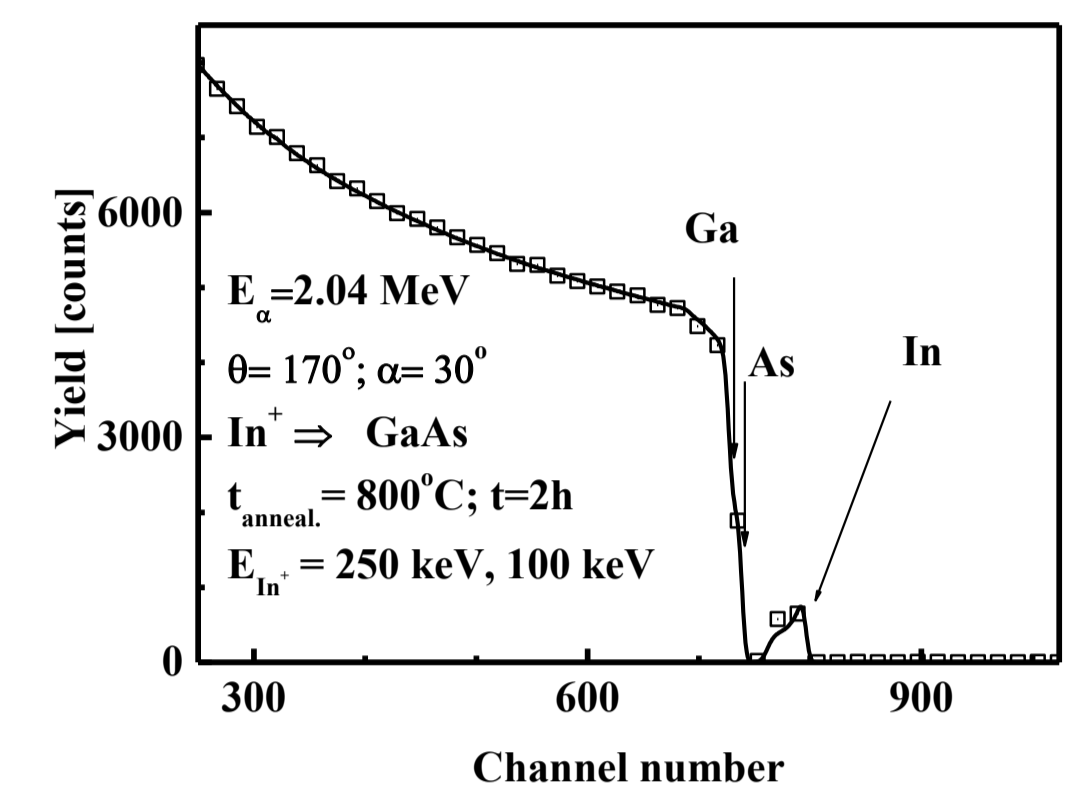
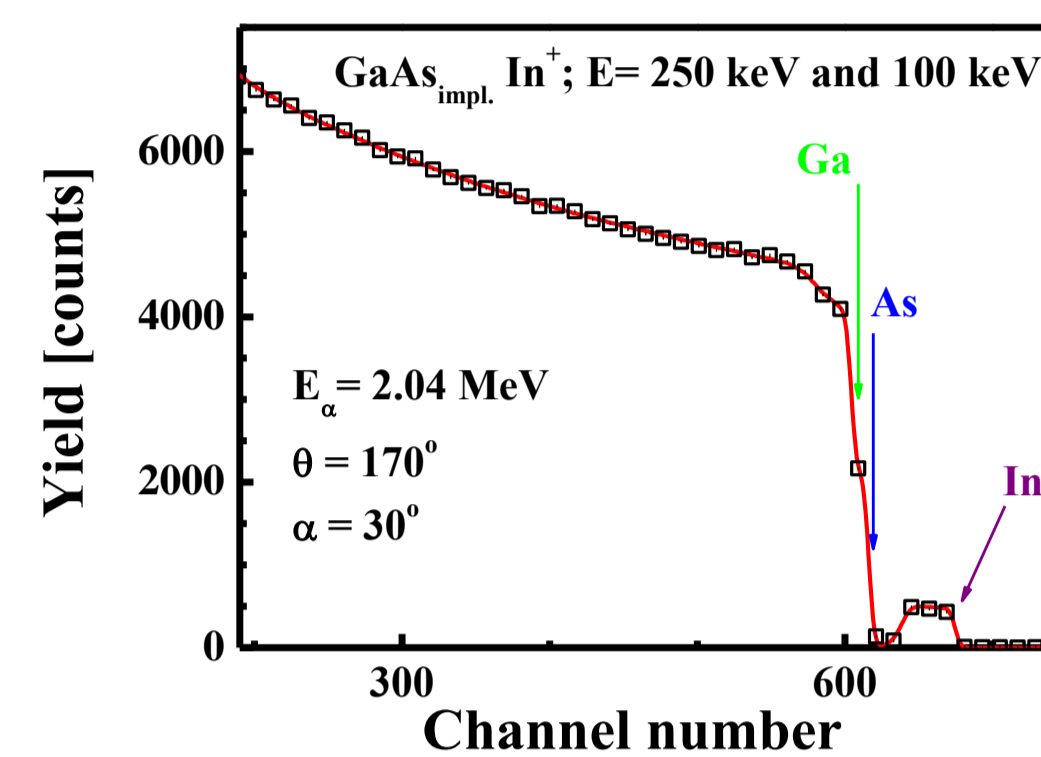
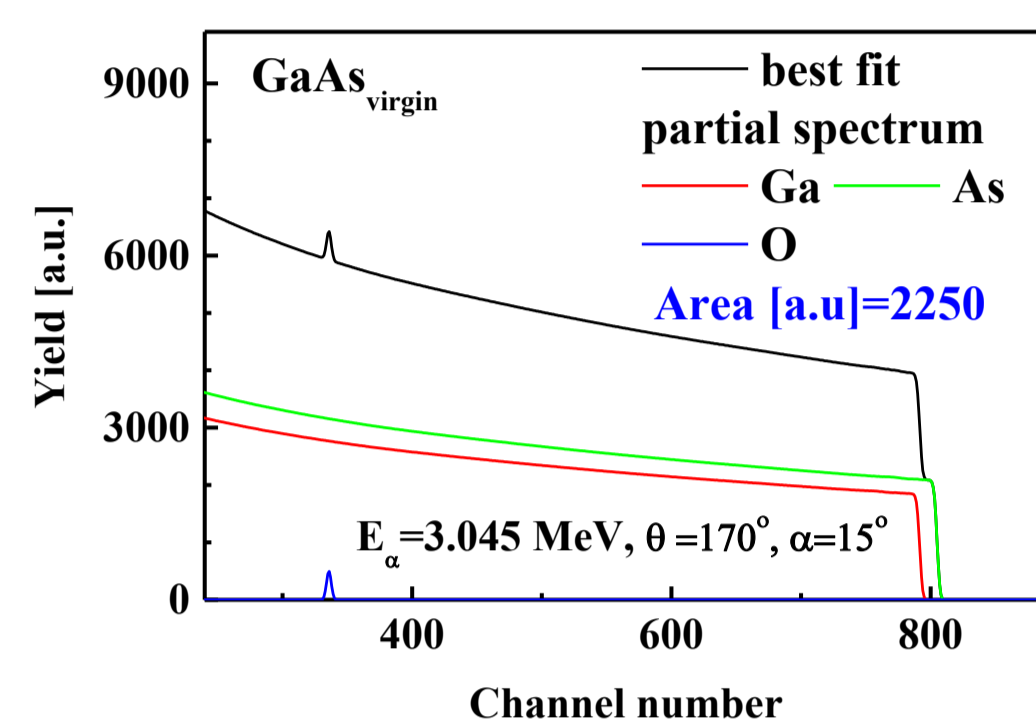
Ellipsometric measurements SE - were performed at room temperature; variable angle spectroscopic ellipsometer (VASE) of J. A. Woollam working in the configuration of a rotating analyzer; Y(λ) and D(λ) were measured at three incidence angles: 65°, 70°, 75° and 80° in the range of wavelength λ = 250-900 nm (with the step of 1 nm).



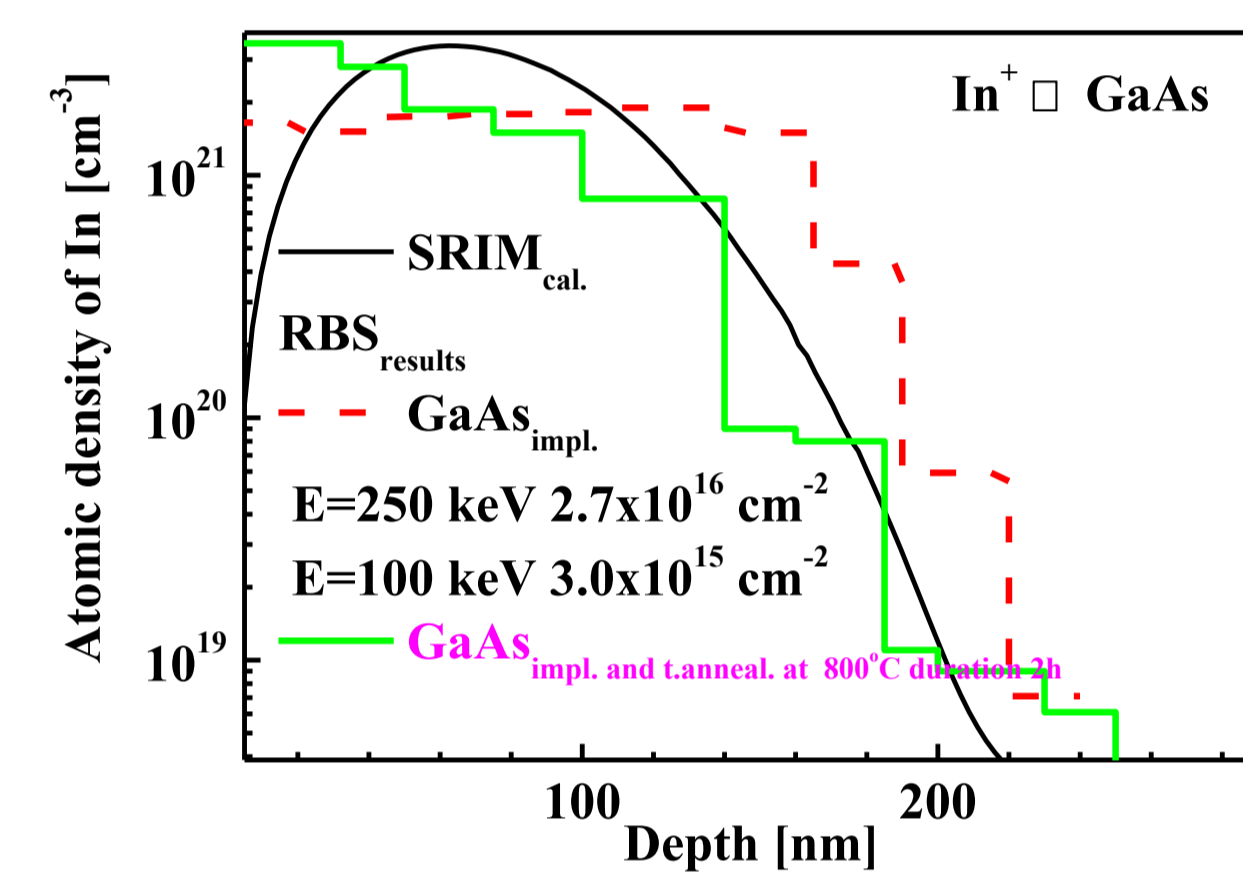
2 cauchy	7.0927 nm
1 ema a-gaas/1.4% gaas	164 nm
0 gaas-virgin	1 mm



RBS/NR investigation



Depth profiles of In

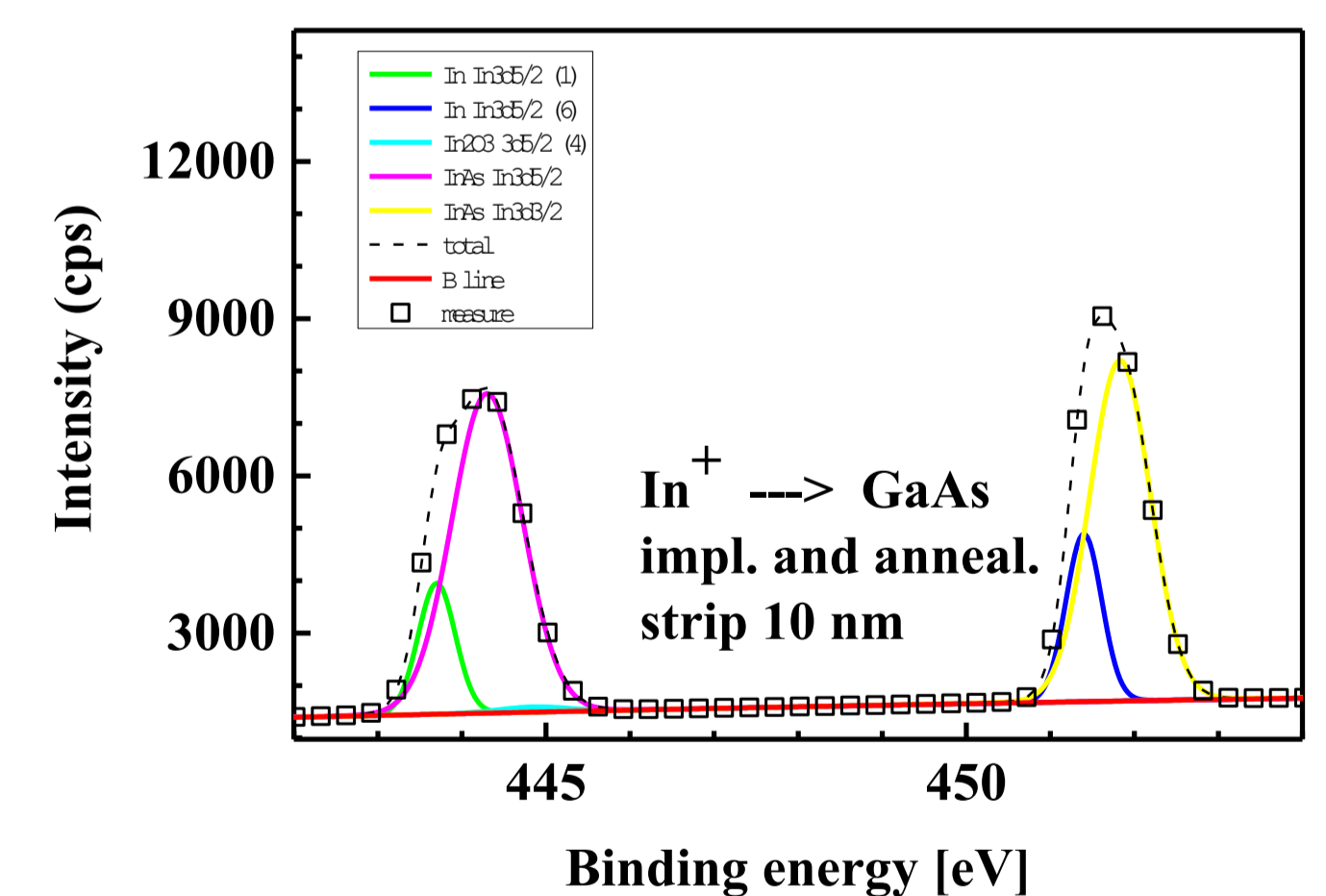
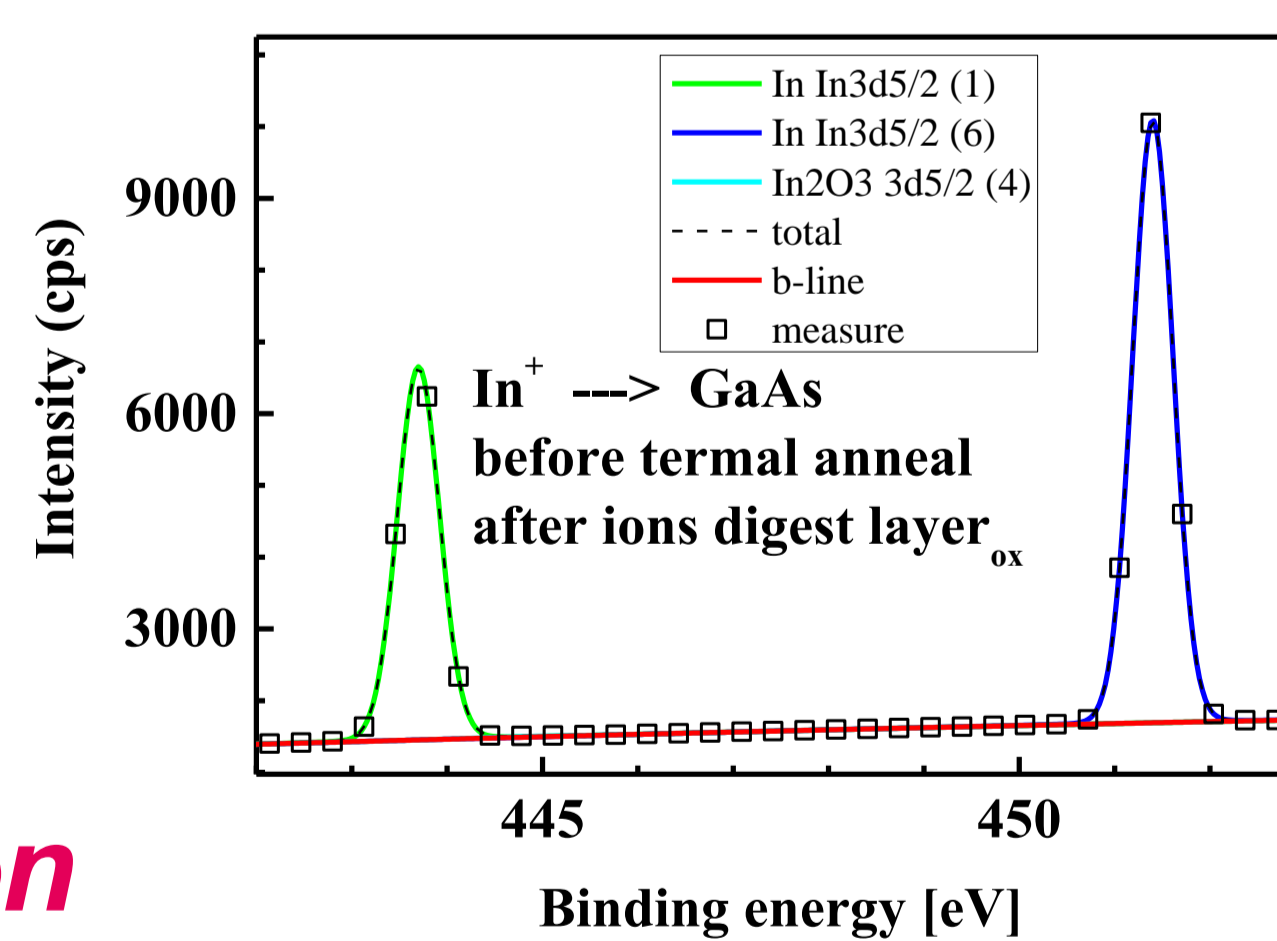
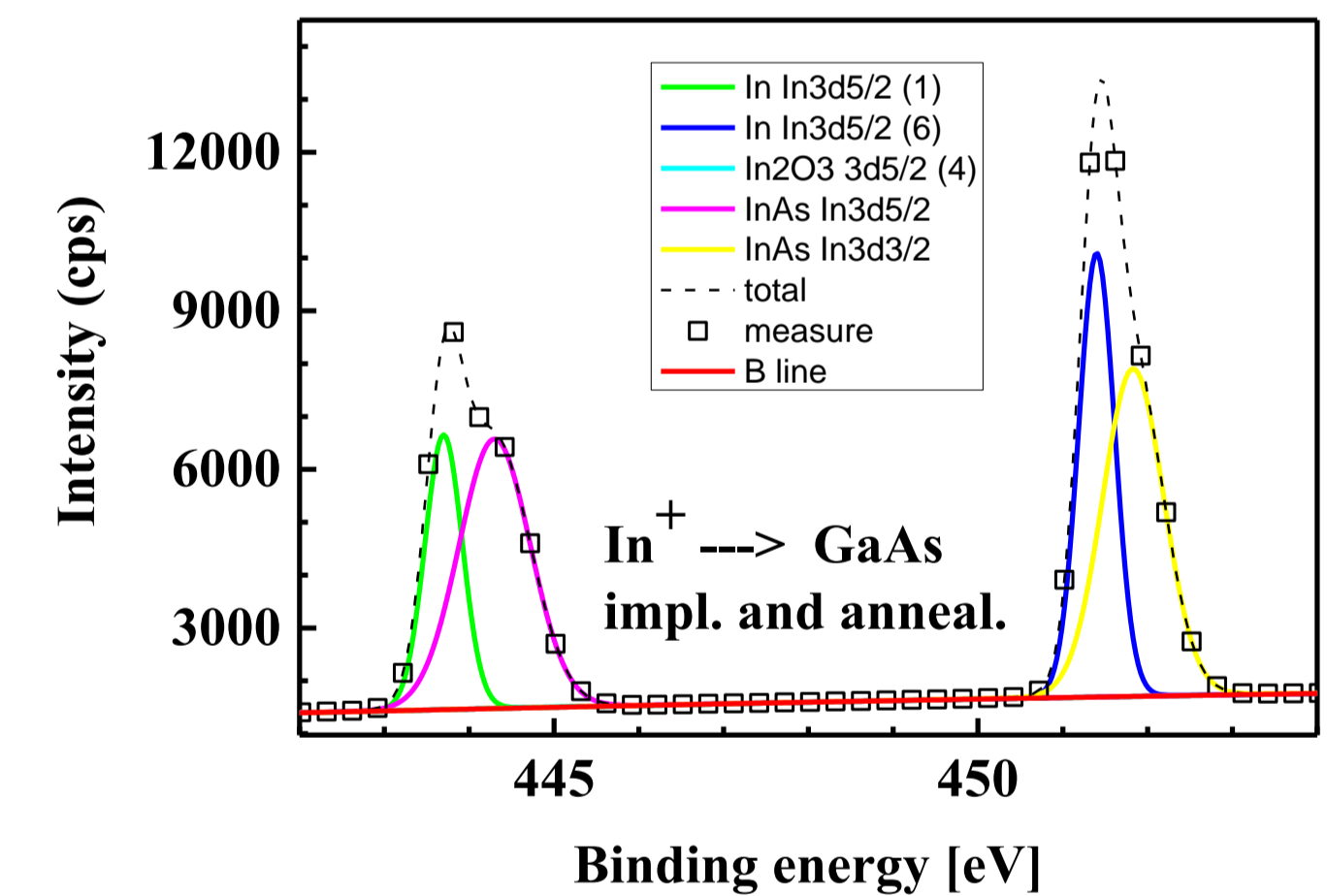
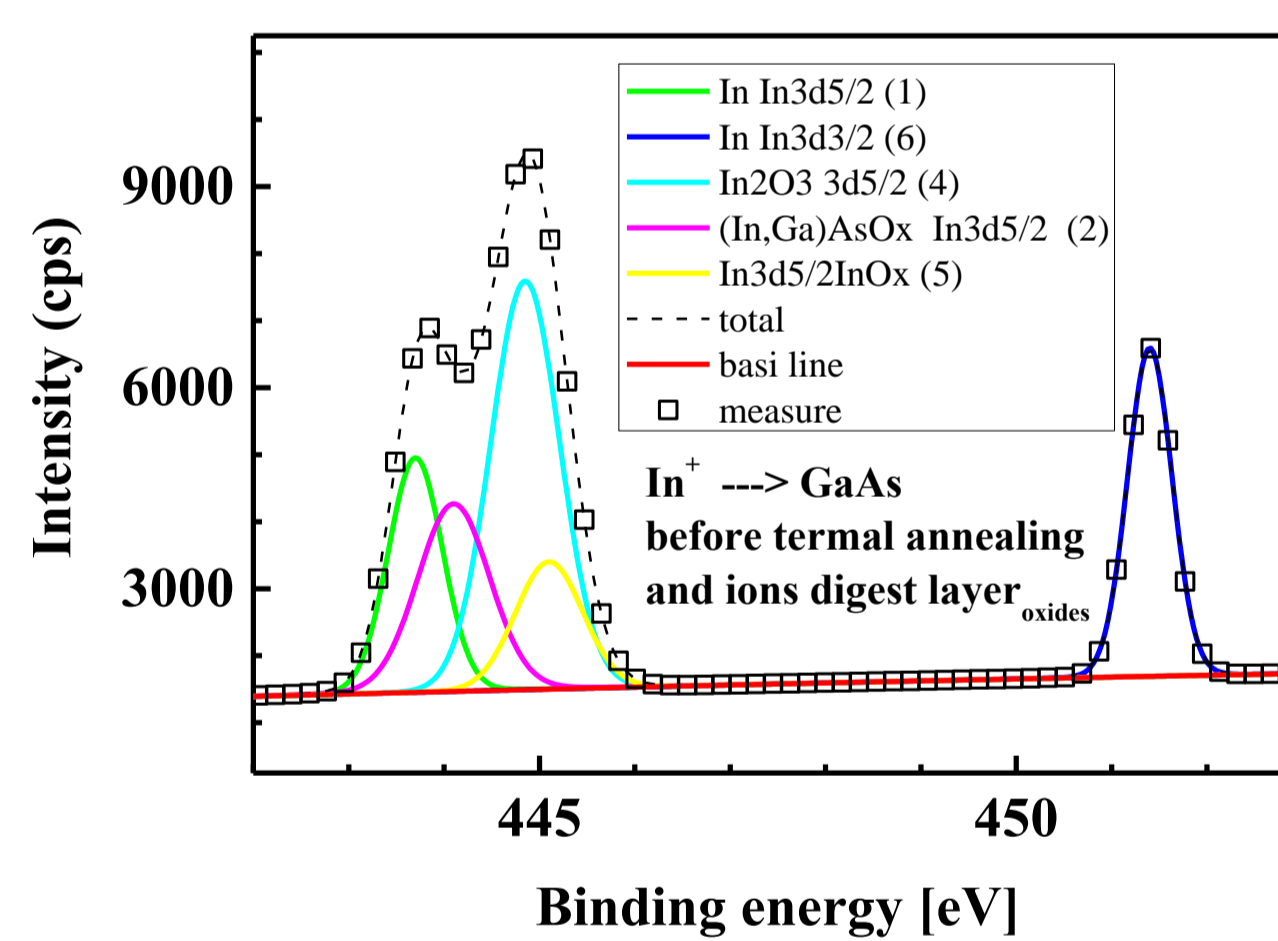


The thickness of the impl. layers:

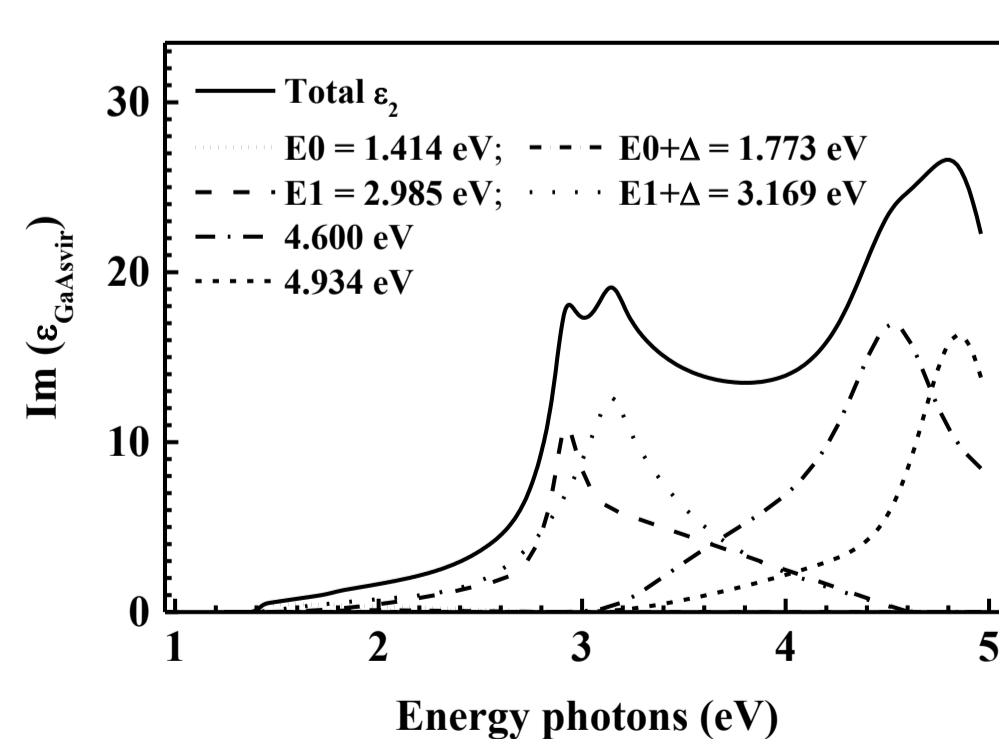
d_{b, anneal.} = 164.0 ± 5.0 nm

d_{a, 2h, 800 C} = 112.0 ± 5.0 nm

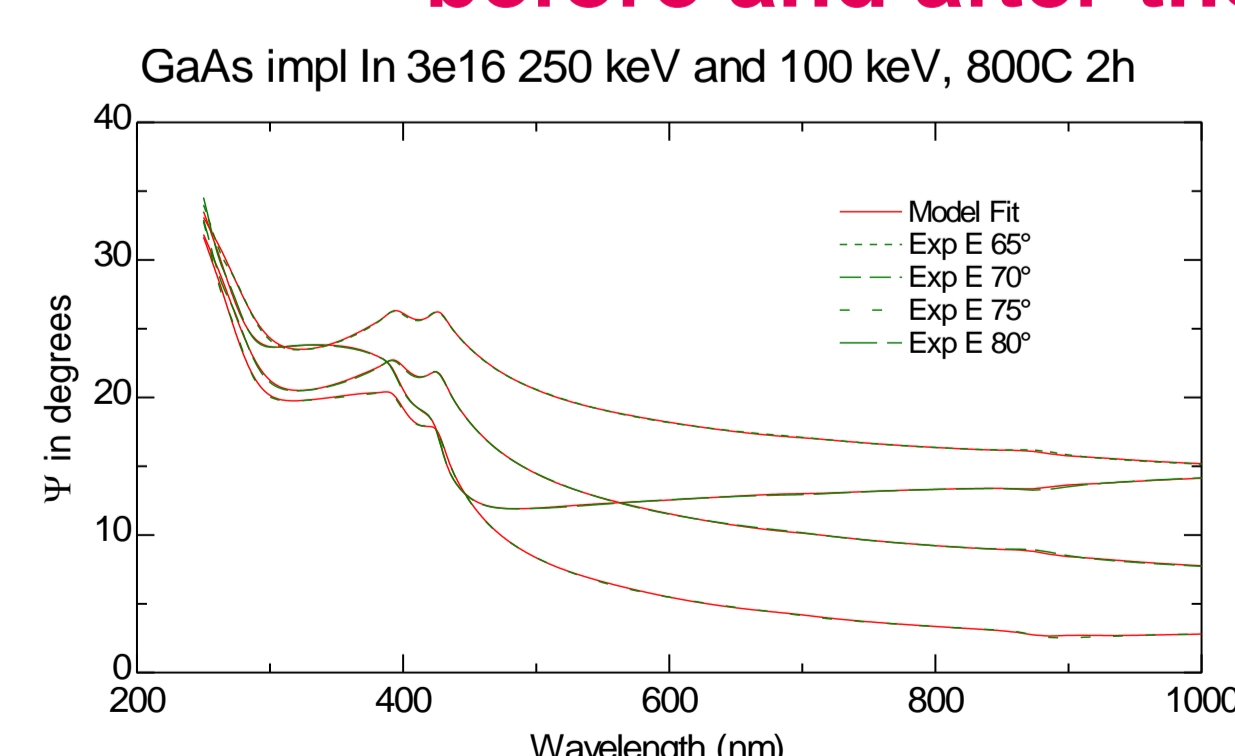
XPS investigation



SE investigation



Dielectric function ε₂ of the implanted layer before and after thermal anneal.



2 cauchy	5.0927 nm
1 gaas_p	112 nm
0 gaasvirgin	1 mm

